

THIS SHEET HAS BEEN
REPLACED

5 COMPLEX CIRCUIT BOARD, NONRECIPROCAL
CIRCUIT DEVICE, RESONATOR, FILTER, DUPLEXER,
COMMUNICATIONS DEVICE, CIRCUIT MODULE, COMPLEX
CIRCUIT BOARD MANUFACTURING METHOD, AND
NONRECIPROCAL CIRCUIT DEVICE MANUFACTURING METHOD

ABSTRACT OF THE DISCLOSURE

In a complex circuit board, the positional
relationships between element portions,
10 including an electrode pattern, a dielectric
substrate and a magnetic substrate, can be adjusted as
desired, and the complex circuit board can be
miniaturized. The complex circuit board
includes a dielectric substrate and a magnetic
15 substrate, a space being provided between the magnetic
substrate and the dielectric substrate, and an electrode
pattern provided between the dielectric substrate and the
magnetic substrate, a capacitance element portion
of the electrode pattern being provided
20 adjacent or in contact with or spaced a
predetermined distance from the dielectric substrate,
and the inductance element portion of the electrode
pattern being provided adjacent
or in contact with or spaced a predetermined distance
from the magnetic substrate.

Fig. 2

